Alkali ratio control for lead-free piezoelectric thin films utilizing elemental diffusivities in RF plasma

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Received (in XXX, XXX) Xth XXXXXXXXX 2013, Accepted Xth XXXXXXXXX 2013
DOI: 10.1039/c0ce00000x

High performance piezoelectric thin films are generally lead-based, and find applications in sensing, actuation, and transduction in realms of biology, nanometrology, acoustics, and energy harvesting. Potassium sodium niobate (KNN) is considered to be the most promising lead-free alternative, but is hindered by the inability to control and attain perfect stoichiometry materials in thin film form while using practical large area deposition techniques. In this work, we identify the contribution of elemental diffusivities in radio frequency (RF) plasma in determining alkali loss in KNN thin films. We have also examined the effect of substrate temperature during the RF-magnetron sputtering deposition on the crystal structure of the substrate and KNN thin films, as well as the effect of post-annealing treatments. These results indicate the need for well-designed source materials and the potential to use deposition partial pressures to alter dopant concentrations.

Introduction

Alkali-based potassium sodium niobate, \( K_{x}Na_{1-x}NbO_3 \) (KNN), material system is one of the most promising lead-free substitutes for the dominant ferroelectric lead zirconate titanate (PZT) system owing to its good piezoelectric properties, high Curie temperature, and modifiability by various dopants. KNN-based thin films have been investigated extensively during the past ten years for applications ranging from optical waveguides and FRAMs to piezoelectric-based devices for energy harvesting applications. KNN-based thin films have been processed by a variety of techniques encompassing chemical deposition such as sol-gel and chemical solution deposition (CSD), and physical deposition such as pulsed laser deposition (PLD) and RF magnetron sputtering. Among these, RF magnetron sputtering is promising due to its capability for large area depositions with lower growth temperatures that makes it viable for integration with fabrication processes. Major challenges in RF magnetron sputtering of KNN-based thin films are non-stoichiometry due to volatility of alkali metals, formation of secondary phases, and high leakage current density. The loss of alkali metals during KNN thin film synthesis was noted in early attempts of PLD and RF magnetron sputtering. Further studies on the effects of different sputtering parameters on the composition, crystal structure, and growth rate of KNN thin films revealed that while crystalline phases and growth rate are largely dependent on sputtering pressure and growth temperature, alkali loss cannot be controlled by varying sputtering parameters. It was suggested then that the alkali volatility can be addressed by excess amount of K and Na species (usually in the ratio of 1.5:1.5:1 for K:Na:Nb) in sputtering targets. Most recently, Kim et al. have studied the effect of post-annealing treatment on the crystal structure and electrical properties of KNN thin films grown on Pt/Ti/SiO_2/Si substrates at a substrate temperature of 300 °C utilizing a stoichiometric target, in different annealing atmospheres. To our knowledge, until now, no comprehensive study has been carried out on the alkali loss and the compositional homogeneity of KNN thin films as a function of oxygen partial pressure during the sputtering process. Such a study offers the potential to control elemental diffusivity during deposition to tailor alkali content and composition ratios. This creates the opportunity to attain different alkali ratios from a single target and also create tailored deficiencies in films for ionic conduction for memristive applications.

This investigation aimed to study the correlation between varying oxygen partial pressure and post-annealing treatment on alkali loss, crystal structure, and surface morphology of KNN thin films as well as to design methods to control their composition and crystal structures using these parameters.

Experimental details

KNN thin films deposition

KNN thin films were deposited by RF magnetron sputtering on platinized silicon substrates with a 200 nm thick platinum layer and a 20 nm thick titanium dioxide adhesion layer. A 100 mm diameter KNN target with the composition \( K_{0.3}Na_{0.7}NbO_3 \) was used for all depositions. The composition of the target was verified using energy dispersive X-ray analysis (EDX) in a scanning electron microscope (SEM). To determine the role of elemental diffusivities on the resulting alkali ratio, the role of...
oxygen partial pressure during deposition and the effect of post-annealing in vacuum and gaseous atmosphere were investigated. The oxygen partial pressure in argon for the process gas during deposition and the effect of post-annealing on their composition, surface chemistry, and crystal structure. Table 1 summarizes sputtering and post-annealing conditions.

### Table 1 Sputtering and post-annealing conditions for KNN thin films

<table>
<thead>
<tr>
<th>Substrate</th>
<th>Pt/TiO₂/Si</th>
</tr>
</thead>
<tbody>
<tr>
<td>Target</td>
<td>(KₓNa₁₋ₓ)NbO₃ [KNN30]</td>
</tr>
<tr>
<td>Process Gas</td>
<td>0, 10, 20, 40% oxygen in argon</td>
</tr>
<tr>
<td>Base pressure</td>
<td>1 × 10⁻² Torr</td>
</tr>
<tr>
<td>Sputtering Pressure</td>
<td>5 × 10⁻² Torr</td>
</tr>
<tr>
<td>Substrate Temperature</td>
<td>700 °C</td>
</tr>
<tr>
<td>RF Power</td>
<td>200 W</td>
</tr>
<tr>
<td>Sputtering Duration</td>
<td>3 h</td>
</tr>
<tr>
<td>Post-Annealing Treatment</td>
<td>1 and 3 h in vacuum (at 700 °C)</td>
</tr>
</tbody>
</table>

sputtering was varied from 0 to 40% in steps of 10% for each sputtering run. KNN thin films were subsequently post-annealed at 700 °C for 1 and 3 h in vacuum and in oxygen atmosphere to study the effects of post-annealing on their composition, surface chemistry, and crystal structure. Table 1 summarizes sputtering and post-annealing conditions.

### X-ray diffraction

The crystallography of the thin films was studied by X-ray diffraction (XRD) using a Bruker D4 Endeavour diffractometer with a copper Kα source. The patterns were collected with a stage rotation of 15 rpm in the 2θ range between 20° and 60° in 0.02° steps, with a collection time of 4 s at each step, in the Bragg-Brentano geometry to account for all possible crystal orientations in the thin films.

### X-ray photoelectron spectroscopy

X-ray photoelectron spectroscopy (XPS) surface and depth profile analyses were carried out using a Thermo Scientific K-Alpha instrument. The surface composition analysis was performed in the central area of the samples with a 5 mm × 1 mm spot size. An aluminum Kα radiation source with energy of 1485 eV was used, with the carbon peaks on the sample surface used as reference for calibration. The composition of the film was determined utilizing the area under the curves, fitted and corrected with sensitivity factors using the Avantage data system. Depth profiling was performed by successive, repeated argon-ion etch and spectrometry processes. This was performed in five consecutive etching steps for 30 s each with low ion beam intensity.

### Results and discussion

Figure 1 shows the X-ray diffractograms for as-deposited KNN thin films. Depositions were performed at a substrate temperature of 700 °C, with varying oxygen partial pressure.

![Figure 1 X-ray diffractograms for as-deposited KNN thin films. Depositions were performed at a substrate temperature of 700 °C, with varying oxygen partial pressure.](image)

The appearance of secondary niobium oxide peaks in XRD can be primarily attributed to excess niobium compared to alkali metals in the films, resulting from the alkali loss during the RF magnetron sputtering with a stoichiometric target. To confirm niobium species indexed in the X-ray diffractograms and study the effect of oxygen partial pressure and post-annealing treatments on the composition of the thin films, a thorough XPS analysis was conducted on the samples.

XPS elemental and depth profile analysis were carried out through the thickness of thin films to characterize elemental ratios variation of sodium, potassium, niobium, and oxygen as a function of oxygen partial pressure and post-annealing treatments, and to determine the compositional homogeneity of the KNN thin films. The elemental ratios for different species are uniform within tolerance levels throughout the thickness of all thin films, excluding the data acquired from the exposed surface of the films as it is subject to ambient contamination. Table 2 shows K/(K+Na) ratio for KNN thin films grown under different oxygen partial pressure conditions and subjected to various post-deposition treatments, highlighting the impact of process gas and post-annealing treatment on the alkali loss and ratio. A lack of oxygen in the sputtering atmosphere results in a dramatic loss of alkali species due to collisions with the argon ions in the RF
plasma and thermal evaporation at the substrate end at high
temperature. As a lighter element, sodium is more prone to the
scattering mechanisms than potassium. Thus, KNN phase was
not observed in the XRD pattern of KNN films deposited in a
pure argon atmosphere. The introduction of oxygen minimizes
sodium loss, with the elemental ratios ranging from 31.7-41.3%
(compared to the 30.0% for the target). Upon introduction of
oxygen into the sputtering atmosphere, negative oxygen ions
formed at the target surface get accelerated into the plasma
towards the substrate. The highly-energetic oxygen ions enhance
the scattering of the ablated perovskite species of the oxide
target which in turn leads to a decrease in the kinetic energy of
the perovskite species. Since the sputtering species reach the
substrate with a lower kinetic energy and surface mobility this
leads to the formation of preferentially ordered grains with
smaller size. Further, oxygen pressure helps the oxidation of the
sputtered species into higher oxidation states leading to the
formation of NbO\(_5\) species for the perovskite crystal structure.

Post-annealing treatments in most cases do not show a significant
change in the as-grown alkali ratio; however, slight increases
observed in most cases indicate further sodium loss.

The ratio of alkali to niobium concentration \([K+(Na)/Nb]\),
which is expected to be 1 (or 100%), was also analyzed (see
Table 3). The elevated loss of alkali metals in the sputtering
process is observed in all films leading to alkali-to-niobium ratios
of 0.1-0.3 in the KNN thin films. This result supports reports.

<table>
<thead>
<tr>
<th>Table 2</th>
<th>K/(K+Na) ratio for KNN thin films grown under different oxygen partial pressure and subjected to various post-annealing treatments at 700 °C. The K/(K+Na) ratio of the sputtering target used is 30%</th>
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<td>Oxygen Partial Pressure (%)</td>
<td>As-Grown</td>
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<td>0</td>
<td>89</td>
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<tr>
<td>10</td>
<td>32</td>
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<td>20</td>
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</table>

<table>
<thead>
<tr>
<th>Table 3</th>
<th>(K+Na)/Nb ratio for KNN thin films grown under different oxygen partial pressure and subjected to various post-annealing treatments at 700 °C. The (K+Na)/Nb ratio of the sputtering target used is 100%</th>
</tr>
</thead>
<tbody>
<tr>
<td>Oxygen Partial Pressure (%)</td>
<td>As-Grown</td>
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<td>10</td>
</tr>
<tr>
<td>10</td>
<td>45</td>
</tr>
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<td>20</td>
<td>37</td>
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<td>40</td>
<td>28</td>
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</table>

that a potential mechanism to compensate for alkali loss is to
have excess alkali concentration in KNN RF magnetron
sputtering targets.

In order to understand the underlying mechanism and
chemical–crystallographic phase changes resulting from such
alkali loss, detailed analysis of the XPS spectra for sodium,
potassium, niobium and oxygen species in the KNN30 thin films
was carried out. Figure 2 presents XPS spectra for these elements
in the as-grown sample deposited under 20% oxygen partial
pressure (chosen based on its preferential orientation, Fig. 1) after
background correcting the as-obtained XPS spectra using Shirley
algorithm, aligning the elemental binding energies to
adventitious carbon (C1s) binding energy of 285 eV and
resolving chemically distinct species using a non-linear least
square fitting procedure. Both potassium and sodium spectra
were found to consist of a single component spectrum that can be
related to KNN structure. Notably, as expected, K2p spectrum
showed the spin orbital pair corresponding to 2p\(3/2\) and 2p\(1/2\) XPS
spectrum for Nb3d shows three different spin orbital pairs,
corresponding to three different niobium species: (i) NbO\(_2\) where
1<δ<2 at 204.3 eV; (ii) NbO\(_2\) at 205.8 eV; and (iii) NbO\(_2\) phase
present in KNN (henceforth called Nb-KNN) at 207.7 eV. Moreover,
O1s spectrum could be de-convoluted into two components with
binding energies at 530.7 eV and 532.5 eV, which correspond to O\(^2-\) ions in the structure of different niobium
oxides, and the adventitious C–O bonds adsorbed on to the
sample surface, respectively.

Further, the effect of different post-annealing treatments on the
composition of the thin films was examined by de-convoluting the
Nb3d core level XPS spectra in corresponding spin orbital
pairs. In as-grown samples and those post-annealed in vacuum for
1 h, NbO\(_2\), NbO\(_2\), and Nb-KNN related peaks were all present.
However, in the thin films annealed for 1 h in oxygen, the NbO\(_2\) peak completely vanished and the peak related to KNN became
significantly more prominent than that of NbO\(_2\) (based on the
integrated peak area). This indicates that the annealing in an
oxygen environment for a sufficient amount of time increases the
tendency of Nb to oxidize towards higher oxidation states,
desirable for attaining the NbO\(_2\) state required for KNN.

Figure 3 shows the evolution of Nb3d peak for the film grown
under 20% oxygen partial pressure as a result of post-annealing
treatments.

XPS spectra of Nb3d through the thickness of films were also
used to determine the uniformity of the oxidation levels at
different thickness levels of the sample. The films deposited
under 10%, 20%, and 40% oxygen partial pressures were studied.

Figure 4 shows the relative concentration of the three different
Nb species at four different depths within the film (based on four
consecutive etch cycles).

The concentration of the Nb-KNN species (as opposed to Nb
species in oxides) decreases through the depth of films post-annealed in vacuum irrespective of the oxygen partial pressure during the sputter deposition process. This phenomenon can be attributed to the lack of oxygen during annealing preventing Nb from attaining a more stable higher oxidation state, as desirable for KNN. Also, the amount of NbO is relatively uniform (about 20%) at the different etch levels. This indicates that limited oxygen was available at greater depths in the film, resulting in the dominance of the sub-stoichiometric NbO species. On the other hand, films post-annealed for 1 h in oxygen exhibit considerably higher Nb species almost uniformly throughout the thickness. This indicates that post-annealing in oxygen atmosphere enables oxygen diffusion through the film thickness, promoting Nb oxidation states (Nb-KNN) desirable for KNN thin films.

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**Fig. 2** XPS spectra for (a) K2p, (b) Na1s, (c) Nb3d, and (d) O1s core levels for as-deposited KNN thin film grown under 20% oxygen partial pressure.

**Fig. 3** Nb3d spectra of the films grown under 20% oxygen partial pressure: (a) as-deposited, (b) post-annealed for 1 h in vacuum, and (c) post-annealed for 1 h in oxygen.
Fig. 4 Relative percentage concentrations of the NbO\(_2\), NbO\(_3\), and Nb-KNN species at consecutive etching levels of the KNN thin films studied (a,h,c) as-deposited and subjected to post-annealing treatment in (d,e,f) vacuum for 1 h and (g,h,i) oxygen for 1 h and grown with (a,d,g) 10%, (b,e,h) 20%, and (c,f,i) 40% oxygen partial pressure.

To study the effects of post-annealing treatments on the crystal structure of thin films, powder diffraction XRD was conducted on the post-annealed samples. Figure 5 presents and compares X-ray diffractograms of as-deposited and post-annealed samples for the films grown under oxygen partial pressures of 10% and 20%.

For thin films grown under 10% oxygen partial pressure at 700 °C, post-deposition annealing in an oxygen atmosphere for 1 h at 700 °C results in considerable growth of KNN (002) and KNN (101) orientations, and the suppression of NbO\(_2\) as observed in the XRD results [Fig. 5(a)].\(^{43,44}\) The KNN (111) peak intensity also decreases, indicating the re-orientation of KNN crystal structure in (002) and (101) directions. Films grown under 20% oxygen partial pressure however, exhibit the growth of KNN crystal structure in (111) direction following post-deposition annealing in oxygen atmosphere [Fig. 5(b)]. Secondary niobium oxide peaks are reduced in intensity in these samples as well indicating the formation and growth of higher order Nb\(^{5+}\) oxidization states, as a result of the annealing treatment, complementary to the results of the XPS analysis (Figs. 3 and 4). These XRD results, considering in combination with the XPS outcomes, allude to the possibility of engineering the crystalline orientation and alkali ratio in KNN thin films through varying the oxygen partial pressure during the sputtering process coupled with specific post-annealing treatments.

Previous studies on the RF magnetron sputtering of KNN thin films have shown that the composition and the growth rate of KNN thin films are not influenced by growth temperature.\(^{17,18,24}\) Further, the crystalline orientation of KNN thin films was proven to be independent on the growth temperature. To substantiate this hypothesis and to test the primary premise that the RF plasma can determine alkali ratios (and thereby, film composition), we carried out depositions on a modified substrate and at a lower temperature.
Fig. 5 X-ray diffractograms for KNN thin films as-deposited at 700 °C and further annealed in oxygen at 700 °C for 1 h. Thin film deposition was carried out at oxygen partial pressures of (a) 10% and (b) 20%.

Fig. 6 X-ray diffractograms for KNN thin films as-deposited at 600 °C and annealed in oxygen at 600 °C for 1 h.

KNN thin films were deposited on Pt/Ti/SiO₂/Si substrates at the growth temperature of 600 °C and post-annealed at 600 °C in oxygen atmosphere for 1 h. Figure 6 shows the X-ray diffractograms for as-deposited and post-annealed thin films grown under 20% oxygen partial pressure at 600 °C. The SiO₂ barrier layer utilized on silicon substrates prior to deposition of platinum thin film prevents the formation of the PtSi layer during deposition at high substrate temperature. As a result, the as-deposited nano-crystalline platinum crystallizes into the thermodynamically stable (111) configuration on exposure to higher temperatures. The resulting KNN thin films show strong c-axis (001) orientation with the absence of the KNN (101) peak. Single crystalline nature of platinum layer as opposed to the polycrystalline Pt–Si layer also prevents the formation of crystalline phases for secondary niobium oxide species. The composition of KNN thin films deposited at 600 °C was examined after post-annealing treatment in oxygen via XPS, revealing its K/(K+Na) ratio to be 44.2%, almost identical to the film grown under 20% oxygen partial pressure at 700 °C and post-annealed in oxygen for 1 h. The (K+Na)/Nb ratio was 43.9%, slightly lower than the ratio at 700 °C. These XPS results highlight that the changes in the deposition temperature and the substrate do not significantly influence the RF plasma diffusivity determined alkali loss and alkali-niobium ratio.

Conclusions

The ability to control alkali concentration and ratio in lead-free KNN thin films has been examined. It has been shown that the lighter alkali species (sodium) experiences greater scattering in the deposition atmosphere; while both alkali species are significantly scattered in comparison to niobium. These results highlight the need to account for such loss in species during the RF sputtering process by tailoring the initial sputtering target composition. Such alkali ratio control by varying oxygen partial pressure, independent of substrate temperature and configuration, also provides a mechanism to vary dopant concentrations in thin film samples using just one sputtering target of fixed composition. Further, the stabilization of the KNN phase has been achieved through the elimination of secondary phases using a facile high-temperature post annealing process in oxygen atmosphere. Moreover, the effect of substrate orientation and crystallinity on the crystal structure of high temperature RF-sputtered KNN thin films was highlighted. Results for thin films sputtered at 600 °C on platinized silicon substrates with thermally grown SiO₂ barriers signal the formation of a strongly (111) textured platinum layer which in turn leads to a strong orientation in the KNN thin films. This further highlights the significance of temperature control during the RF deposition which allows for the effective control of the orientation in metallic substrate layer and in turn the preferential orientation in KNN perovskite oxide thin films.

Acknowledgements

Funding support for the project from the Australian Research Council (ARC) through Discovery Projects DP1092717 and DP130100062 and infrastructure grants LE0882246 and LE0989615 are acknowledged. V.B., S.S., and M.B.
acknowledge Australian Post-Doctoral Fellowships from the ARC through DP0988099, DP110100262, and DP1092717, respectively. The authors also acknowledge the facilities and technical assistance of the Australian Microscopy & Microanalysis Research Facility at the RMIT Microscopy & Microanalysis Facility.

Notes and references